

Supporting Information

High performance n-channel organic thin film transistor based on naphthalene diimide

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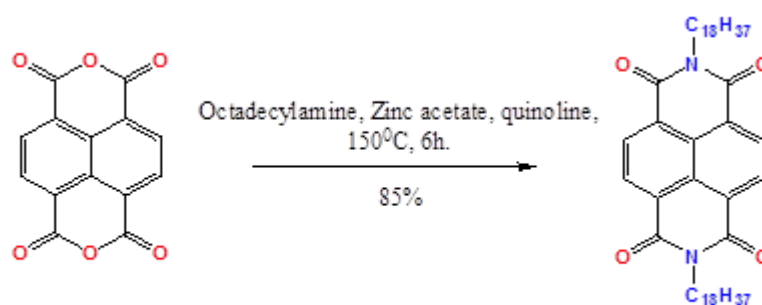


Figure S1: Synthesis of NDI-OD2

NDI-OD2 was synthesized by direct condensation of naphthalene dianhydride with octadecylamine. A mixture of 1, 4, 5, 8-naphthalenetetracarboxylic acid anhydride (0.5 g, 1.8 mmol), octadecylamine (3g, 11.16 mmol), and zinc acetate (25 mg) in 15 mL quinoline was heated at 150 °C for six hours. The mixture was cooled and diluted with several volumes of methanol. The resulting slurry was filtered; the collected solid washed with methanol and dried in air. The crude product was then purified by column chromatography using hexane-chloroform as eluent. (Yield: 85%). ¹H NMR (400 MHz, CDCl₃) δ (ppm): 8.76 (s, 4H), 4.17 (t, 4H), 1.72 (m, 4H), 1.22 (m, 60H), 0.93 (t, 6H) ppm. ¹³C NMR (100 MHz, CDCl₃) δ (ppm): 163.03, 131.12, 129.00, 126.97, 41.21, 32.13, 29.90, 29.57, 28.29, 27.29, 23.19, 14.32. FT-IR (KBr, cm⁻¹, ν): 2921, 2847, 1707, 1657, 1338, 1246, 766.

Gaussian Calculation:

Software used= Gaussian 03

Basis set used= B3LYP/6-31G (d)

Molecule:

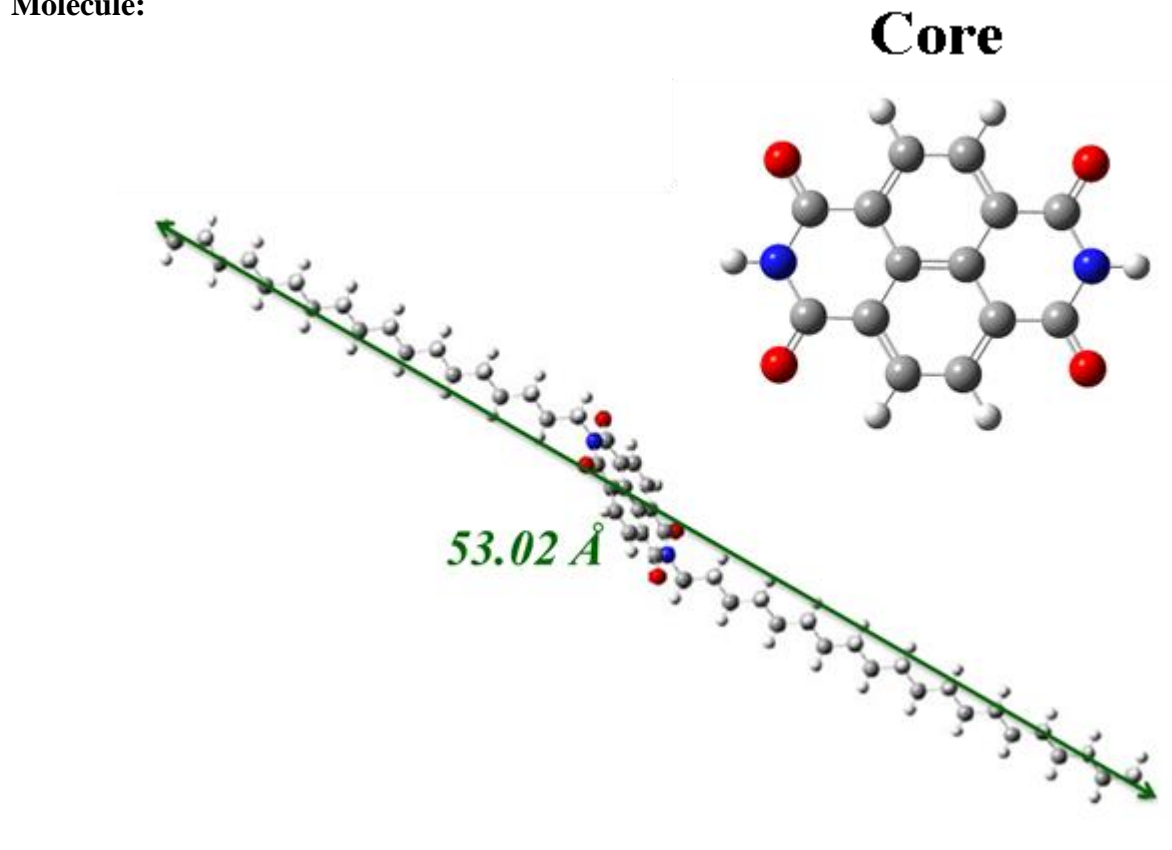


Figure S2. The molecular structure of NDI-OD2.

DFT Calculation Data:

Alpha occ. eigenvalues --	-0.42100	-0.41942	-0.41874	-0.41843	-0.41717
Alpha occ. eigenvalues --	-0.41573	-0.41119	-0.41091	-0.40890	-0.40562
Alpha occ. eigenvalues --	-0.40344	-0.40166	-0.39599	-0.39257	-0.39166
Alpha occ. eigenvalues --	-0.39036	-0.38929	-0.38405	-0.38246	-0.37708
Alpha occ. eigenvalues --	-0.37661	-0.36946	-0.36693	-0.36630	-0.36462
Alpha occ. eigenvalues --	-0.36339	-0.36035	-0.35988	-0.35209	-0.35063
Alpha occ. eigenvalues --	-0.34894	-0.34627	-0.34593	-0.33778	-0.33761
Alpha occ. eigenvalues --	-0.33722	-0.33697	-0.33165	-0.33084	-0.32797
Alpha occ. eigenvalues --	-0.32786	-0.32753	-0.32746	-0.32195	-0.32182
Alpha occ. eigenvalues --	-0.32169	-0.32157	-0.31851	-0.31849	-0.31827
Alpha occ. eigenvalues --	-0.31823	-0.31698	-0.31697	-0.31682	-0.31655
Alpha occ. eigenvalues --	-0.31646	-0.31591	-0.31589	-0.31567	-0.31567

Alpha occ.eigenvalues -- -0.30443 -0.30421 -0.29758 -0.29019 -0.28745
 Alpha occ.eigenvalues -- -0.28407 -0.28270 -0.27940 -0.27659 -0.27500
 Alpha occ.eigenvalues -- -0.27365 **-0.25665**
 Alpha virt.eigenvalues -- **-0.12366** -0.05874 -0.04420 -0.03655 0.02140
 Alpha virt.eigenvalues -- 0.02294 0.08844 0.08848 0.09067 0.09129
 Alpha virt.eigenvalues -- 0.09153 0.09582 0.09596 0.09882 0.10100
 Alpha virt.eigenvalues -- 0.10273 0.10603 0.10895 0.10950 0.10978
 Alpha virt.eigenvalues -- 0.11216 0.11311 0.11547 0.11686 0.11831
 Alpha virt.eigenvalues -- 0.11891 0.11954 0.12077 0.12565 0.12635
 Alpha virt.eigenvalues -- 0.12733 0.12791 0.12834 0.12997 0.13627
 Alpha virt.eigenvalues -- 0.13821 0.14173 0.14289 0.14358 0.14464
 Alpha virt.eigenvalues -- 0.14629 0.15000 0.15146 0.15616 0.15658
 Alpha virt.eigenvalues -- 0.15888 0.15941 0.16410 0.16450 0.17018
 Alpha virt.eigenvalues -- 0.17049 0.17161 0.17452 0.17584 0.17833
 Alpha virt.eigenvalues -- 0.17880 0.18418 0.18504 0.19058 0.19145
 Alpha virt.eigenvalues -- 0.19482 0.19534 0.19542 0.19586 0.19687
 Alpha virt.eigenvalues -- 0.19803 0.19939 0.19958 0.19981 0.19985
 Alpha virt.eigenvalues -- 0.20026 0.20080 0.20125 0.20193 0.20302

Calculation of theoretical band gap:

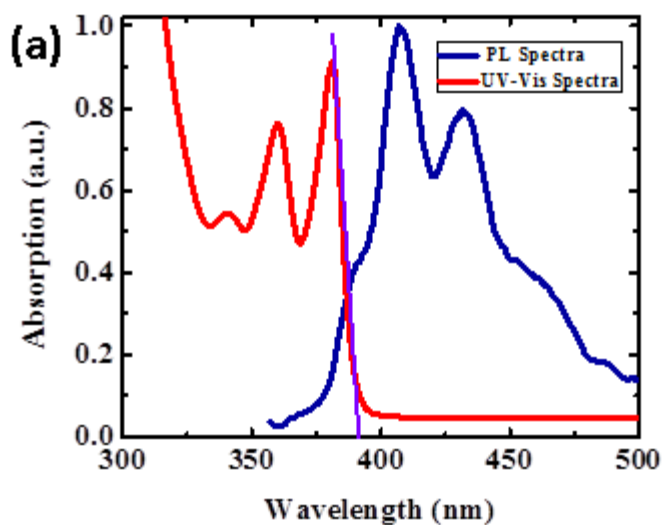
HOMO= - 0.25665*27.2116= - 6.9797754 eV [27.2116 is the unit conversion constant]
 LUMO= - 0.12366*27.2116= - 3.364986546 eV

Band Gap= LUMO-HOMO= E_g^{Th} =3.614788944 eV

Optical Band Gap Calculation from UV-Vis Spectra:

Liquid State:

$$\begin{aligned}\text{Optical Band Gap} &= \frac{1240}{\lambda_{\text{onset}}} \\ &= \frac{1240}{392} \\ &= 3.16 \text{ eV}\end{aligned}$$



Solid State:

$$\begin{aligned}\text{Optical Band Gap} &= \frac{1240}{\lambda_{\text{onset}}} \\ &= \frac{1240}{410} \\ &= 3.02 \text{ eV}\end{aligned}$$

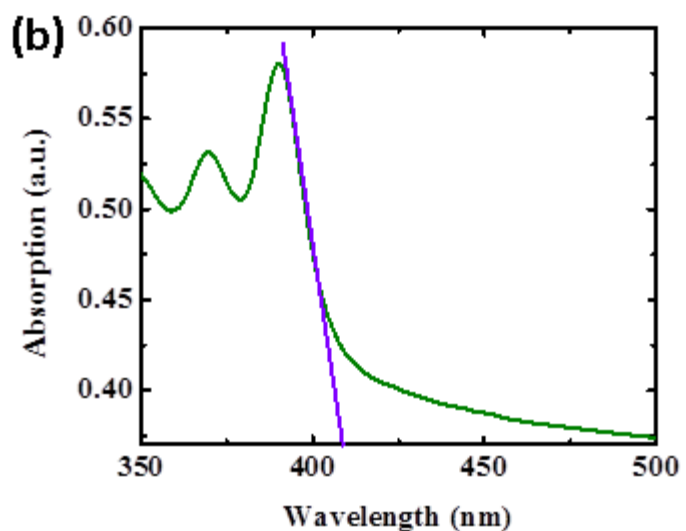


Figure S3. (a) Liquid state (b) Solid State UV-Vis spectra of NDI-OD2 molecule.

Band Gap Calculation from Electrochemistry:

$$E_{LUMO} = -2.955 \text{ eV}$$

$$E_{HOMO} = E_{LUMO} - E_{g(opt)} \quad [E_{g(opt)}(\text{solid state}) = 3.02 \text{ eV}]$$

$$E_{HOMO} = (-2.955 - 3.02) \text{ eV} = -5.975 \text{ eV}$$

Thermal Deposition Curve of NDI-OD2:

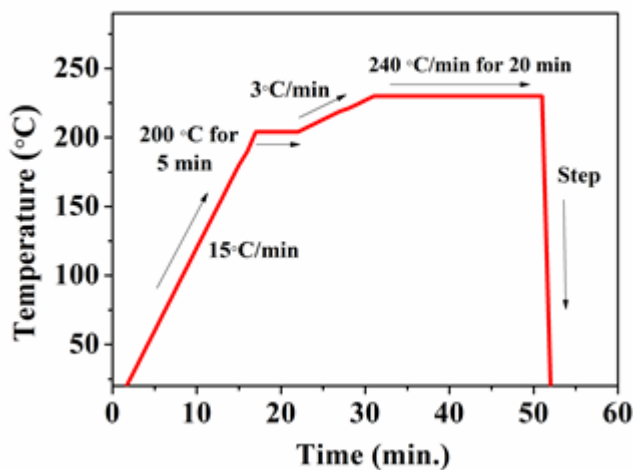


Figure S4. Thermal deposition curve of NDI-OD2

Substrate Cleaning and Film Preparation Technique for Various Spectroscopic and Microscopic Studies:

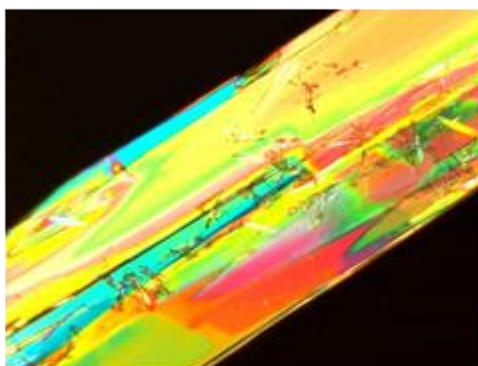
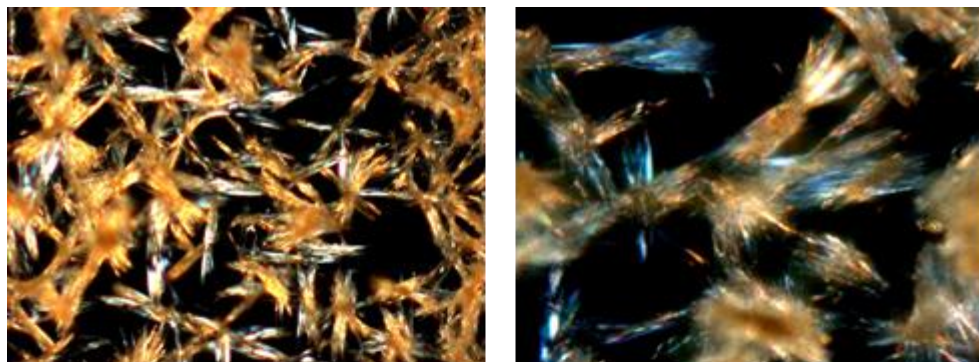
For performing spectroscopic and microscopic studies glass slides were cut into ~1 cm X ~1 cm square substrates. All the substrates were dipped in Piranha solution for approximately 30 min and then cleaned by the following general step wise procedure by sonication in detergent, deionized water, acetone and isopropanol for 20 min each at room temperature. After that the slides are dried in vacuum oven.

Spin Cast Technique A solution of NDI-OD2 was prepared in chloroform at a conc. of 10^{-3} M. Then the monomer solution was spin-coated on the clean glass slide at 2000 rpm for 2 min by Apex Instrument-SpinNXG-P1 and then dried at room temperature. The thicknesses of the films are found ~60-70 nm when measured by Veeco Dektak 150 Surface Profilometer.

Thermal Deposition Technique Thin films of NDI-OD2 monomer were also prepared by thermal deposition technique using Excel Instrument. The monomer was sublimed at 230 °C and the deposition was carried out for 20 min under 10^{-7} mbar pressure. The substrate temperature was kept at room temperature. After deposition the thickness of the film (~ 60 nm ± 10) was confirmed by Veeco Dektak 150 Surface Profilometer.

Polarised Microscopy Images of NDI-OD Monomer:

(a) Spin cast:



Single wire of NDI-OD2

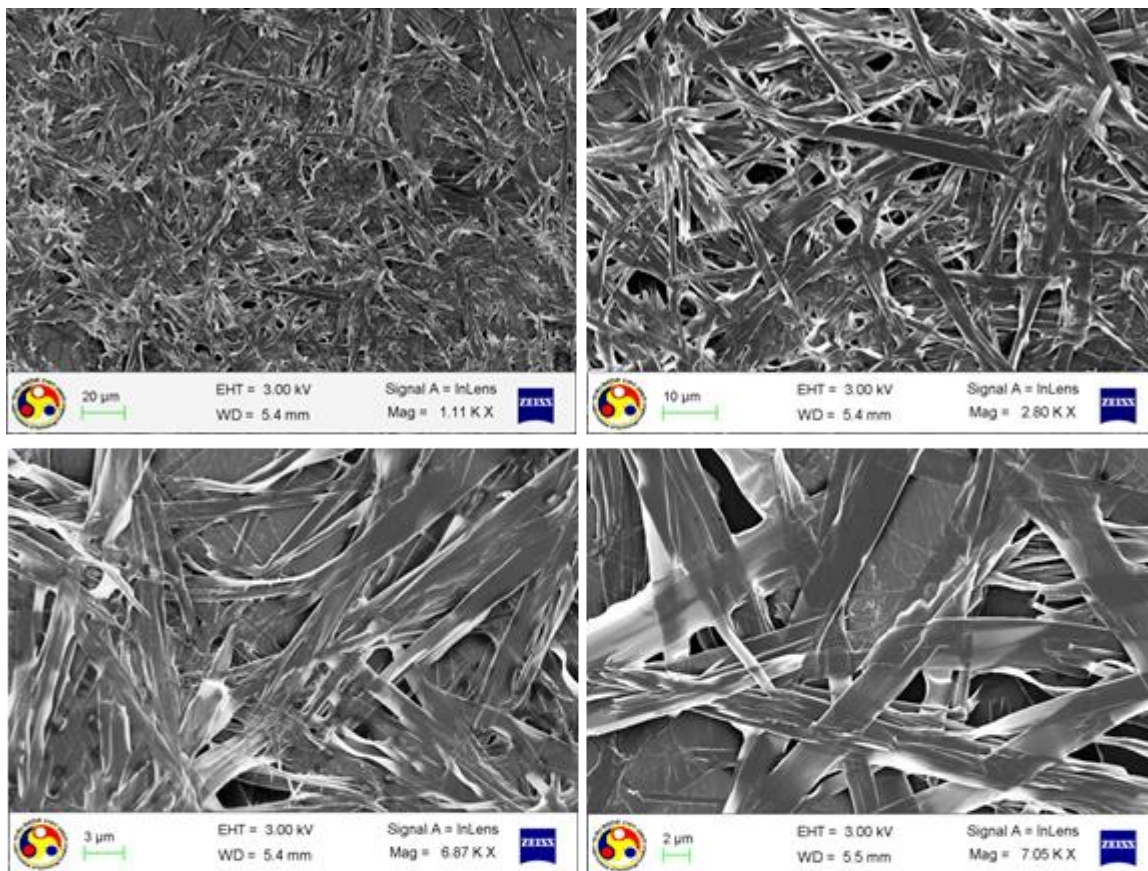
(b) Thermally deposited:



Figure S5. Polarized microscopy of (a) spin cast and (b) thermally deposited films of NDI-OD2 monomer in different magnification range.

FESEM Image of NDI-OD2 Monomer:

(a) Spin Cast:



(b) Thermally deposited:

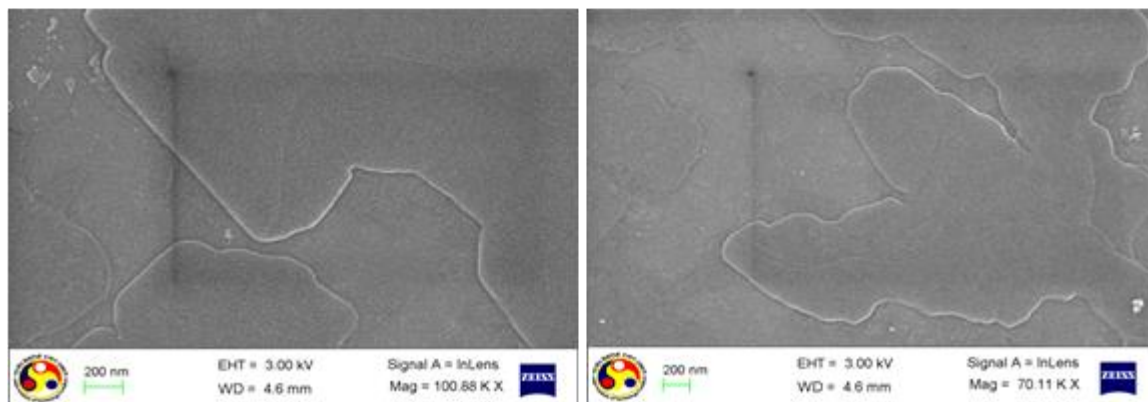


Figure S6. FESEM (a) spin cast and (b) thermally deposited films of NDI-OD2 monomer in different magnification range.

Atomic Force Microscopy Images:

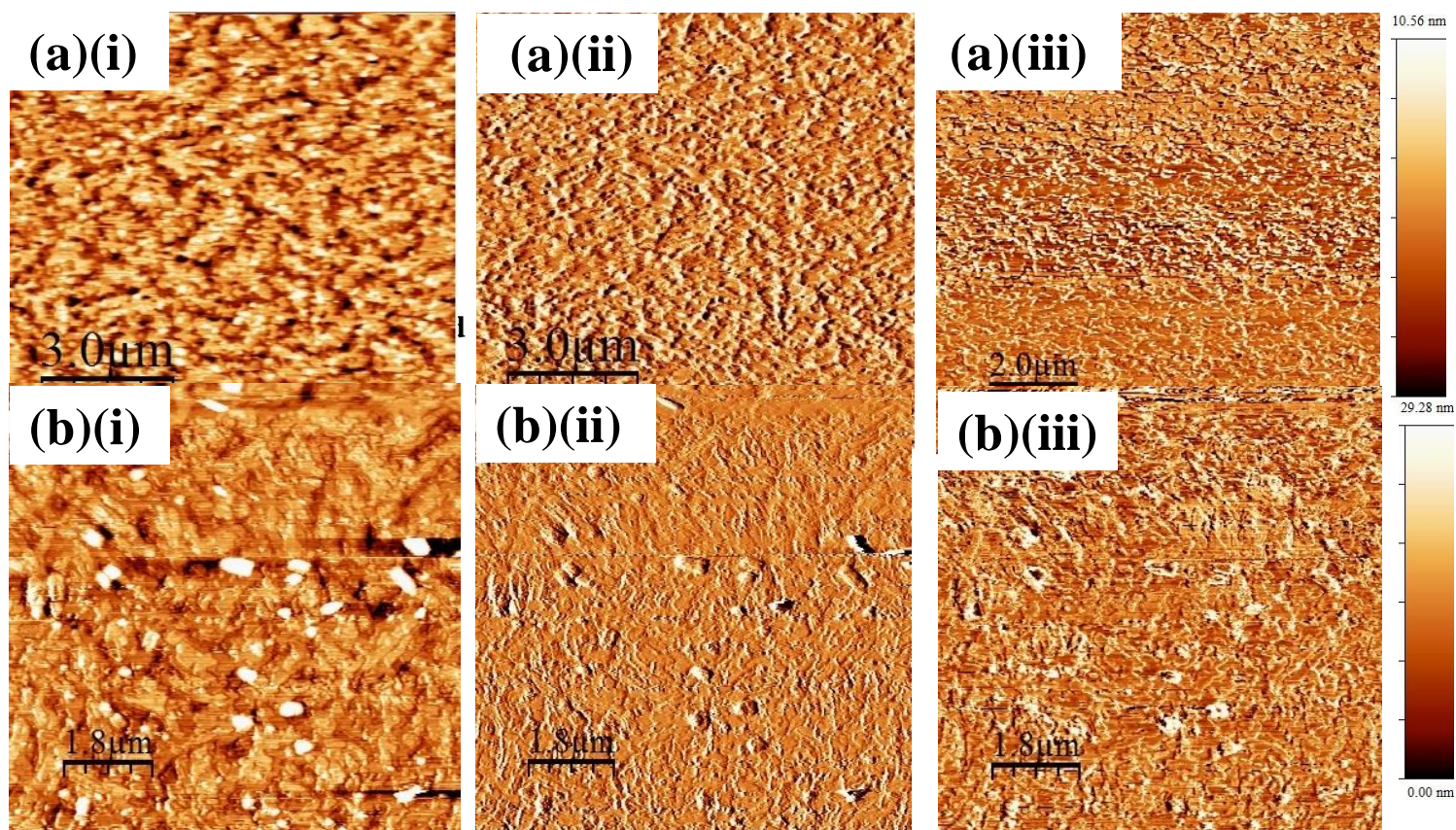


Figure S7. AFM (a) (i) topography, (ii) amplitude, (iii) phase images of spin cast and (b) (i) topography, (ii) amplitude, (iii) phase images of thermally deposited films of NDI-OD2 monomers respectively.

Transmission Electron Microscopy Images:

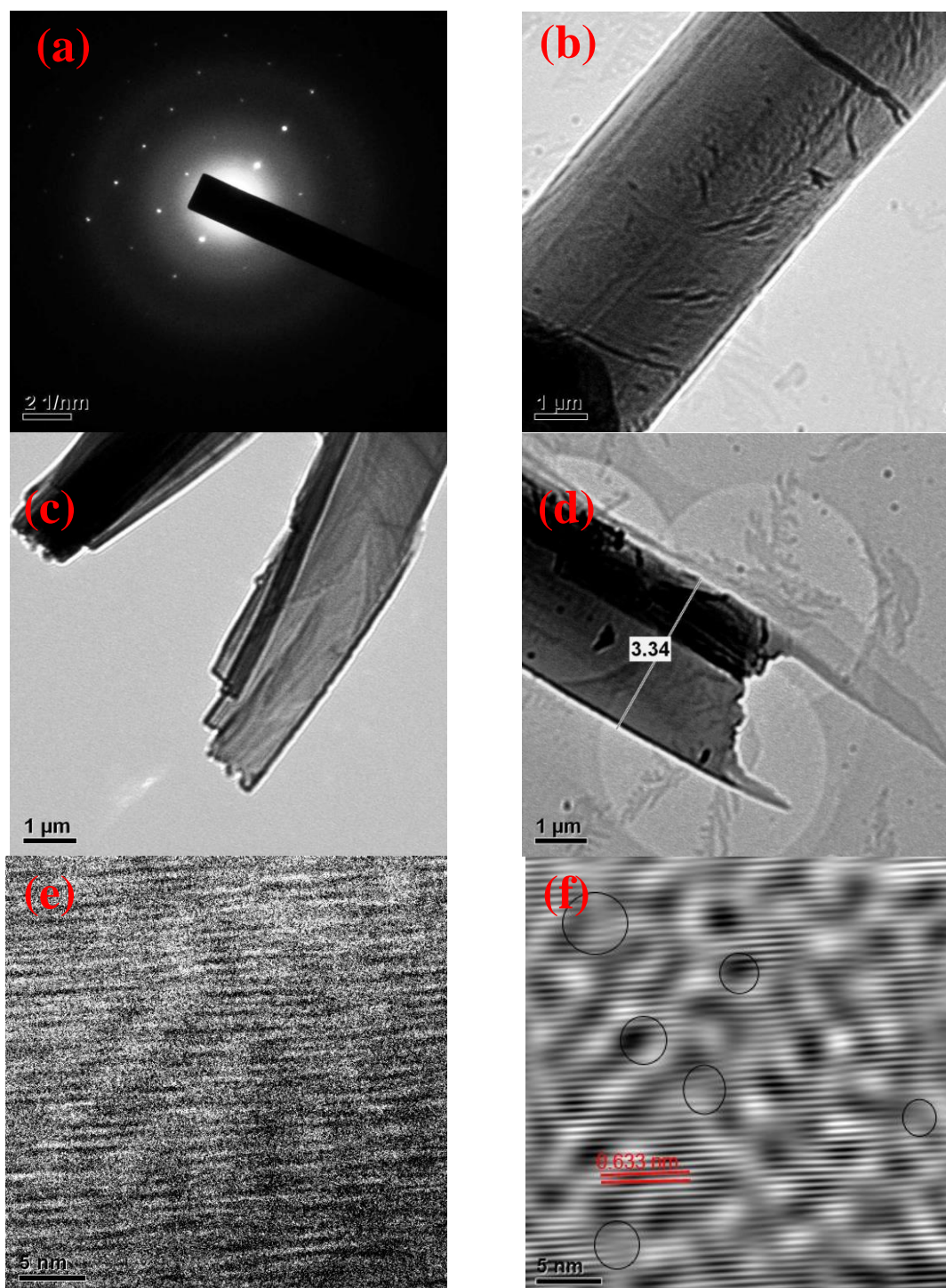
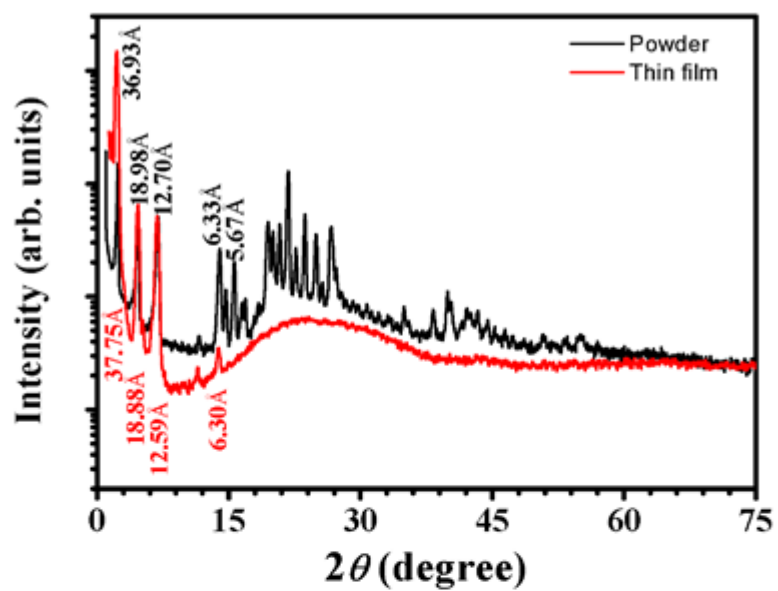


Figure S8. TEM (a) SAED pattern (b), (c), (d) TEM images at different portion of the film (e), (f) HRTEM images of NDI-OD2.

XRD Data:

(a)



(b)

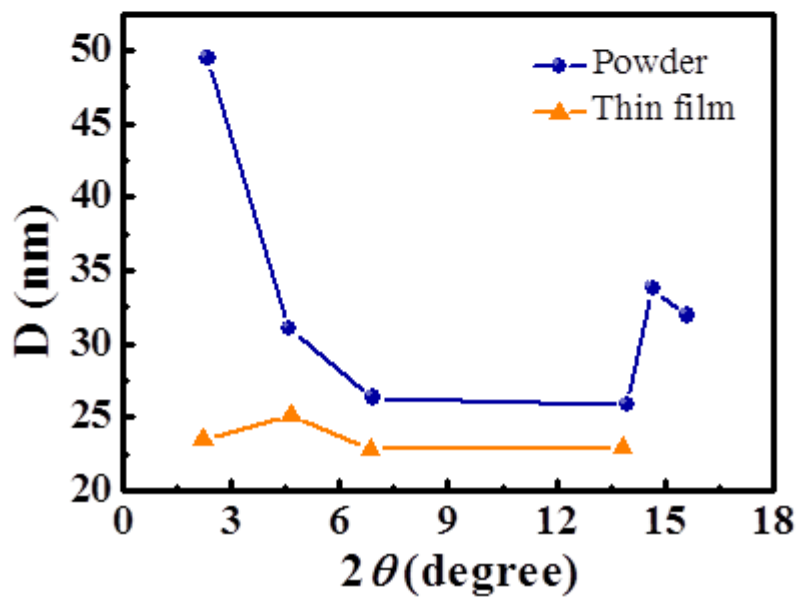


Figure S9. (a) XRD pattern (b) Particle size vs. 2θ graph of NDI-OD2.

Device Fabrication:

Procedure:

Glass slides were cut into ~1 cm X ~2 cm rectangle dimensions. Similar to the procedure followed for cleaning the glass substrates for microscopic and spectroscopic studies, the same general substrate cleaning method was applied here followed by drying in vacuum oven for 20 min. Glass substrates of dimensions ~1 cm X ~2 cm were cut and cleaned using the following procedure. The substrates were sonicated for 10 minutes in detergent, followed by step wise sonication with deionized water, acetone and isopropanol for 20 minutes each at room temperature followed by drying in a vacuum oven for 20 minutes. An L-shaped aluminum gate electrode film (100 nm) was thermally deposited on the substrate under 10^{-6} mbar pressure. A spin coated film of polyvinyl alcohol (PVA) with thickness of (~1 μ m, 1000 rpm) was deposited as a dielectric material having capacitance ~8.854 nF/cm². Thin film of NDI-OD2 (~60 nm \pm 10 nm) was thermally deposited (10^{-7} mbar) on the dielectric layer followed by aluminum source and drain contacts (100 nm) deposition on this NDI-OD2 organic layer through a shadow mask with channel length (L) and width (W) of 50 μ m and 1 mm respectively. Electrical measurements of OTFT devices were carried out under vacuum ($\sim 10^{-4}$ mbar) using a Keithley 4200-SCS semiconductor parameter analyzer. The field-effect mobility was calculated in the saturation regime by using the equation $I_{DS} = (\mu_e W C_i / 2L)(V_G - V_T)^2$, where I_{DS} is the drain-source current, μ_e is the field-effect mobility, W is the channel width, L is the channel length, C_i is the capacitance per unit area of the gate dielectric layer, V_G is the gate voltage, and V_T is the threshold voltage. For analyzing the moisture related stability of the fabricated OTFT devices, the tests were performed at an interval of 24 hours with the devices being continuously exposed to environment having >80% humidity levels at room temperature until the devices degraded completely.

Device Block Diagram

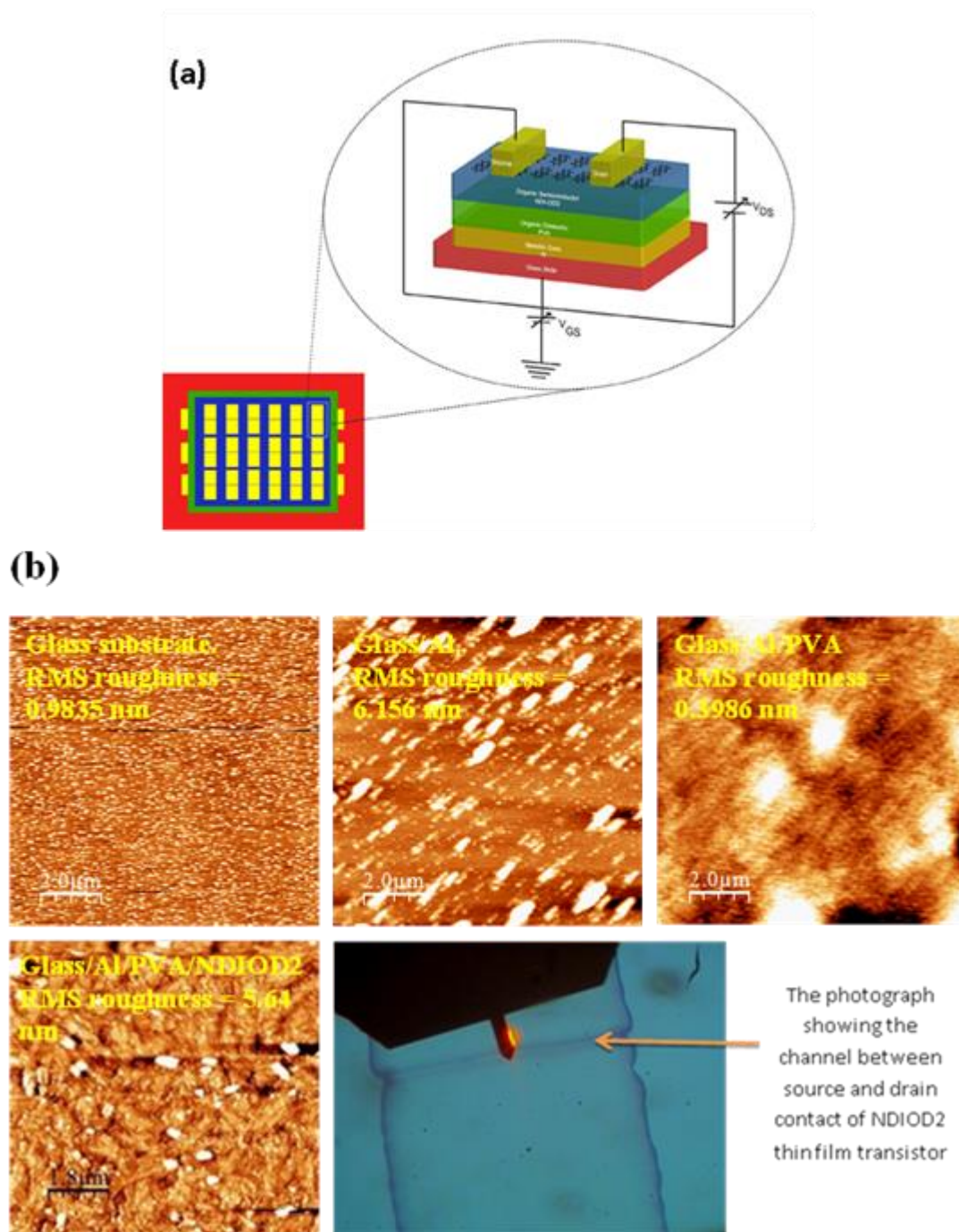
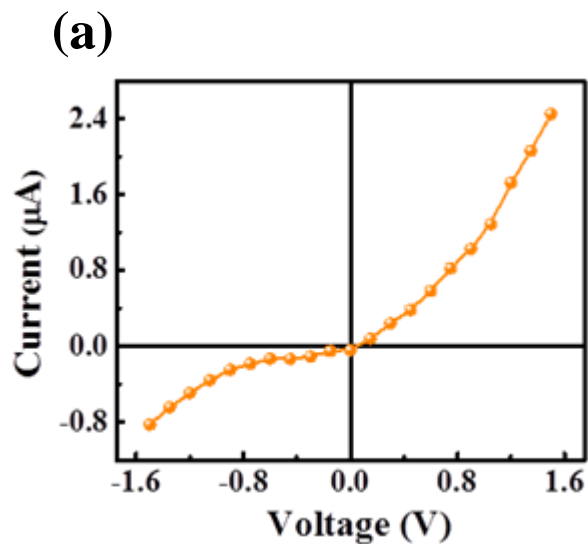
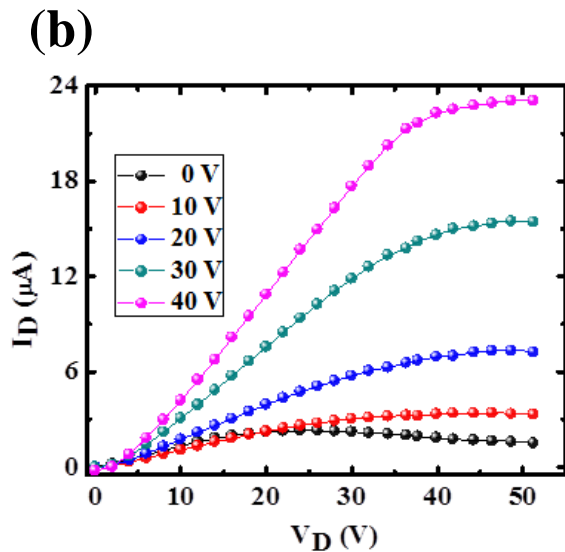


Figure S10. (a) Schematic of the device and (b) Layer-by layer AFM images of the of the NDI-OD2 monomer based OTFT device.

I-V Characteristics



Output Characteristics



Transfer Characteristics

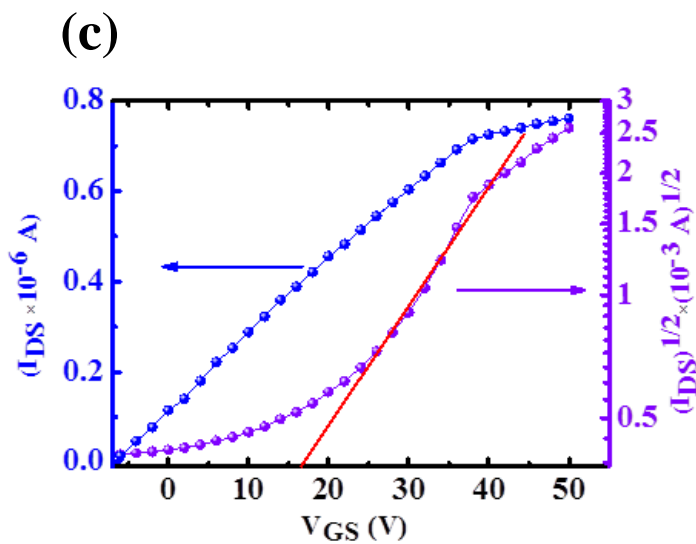


Figure S11. (a) I-V Characteristic (b) Output characteristics and (c) Transfer characteristics of the NDI-OD2 monomer respectively.

Degradation Data:

Transfer Characteristics:

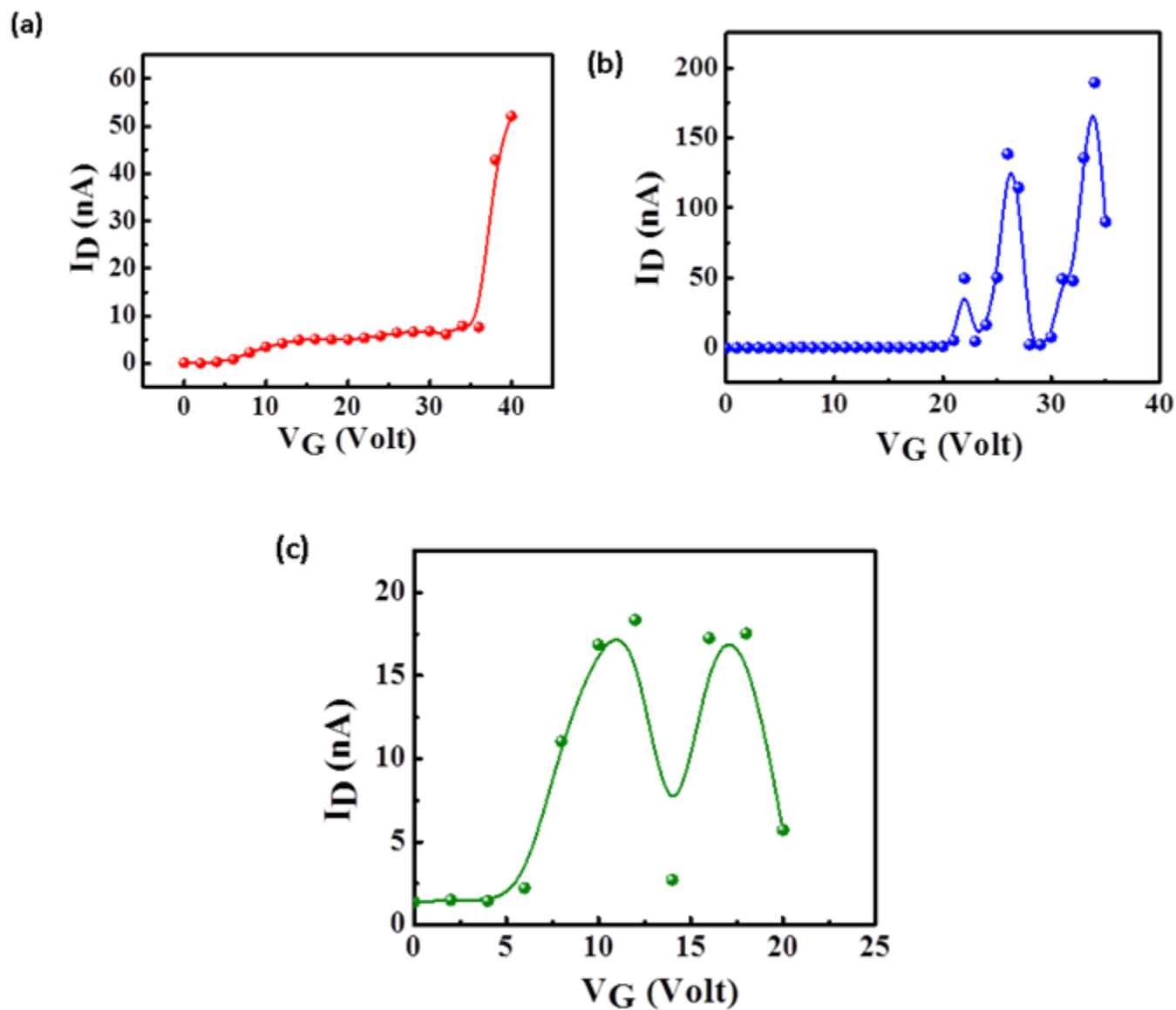


Figure S12. Transfer Characteristics of the NDI-OD2 OTFT device (a) after 4 days (b) after 7 days and (c) after 10 days exposure to moisture.